Notification Number: 20220509001.0 Notification Date: May 10, 2022						ay 10, 2022	
Title: Datasheet for SNx4HC244							
Customer Contact: PCN Manager				Dept:		Quality Services	
Change Type:				_			
Assembly Site		Design				Bump Site	
Assembly Process		y Data Officet		Щ	Wafer Bump Material		
Assembly Materials Machanical Specification			r cnange	H	Wafer Bump Process Wafer Fab Site		
					Wafer Fab Materials		
		Test Process		H	Wafer Fab Process		
Notification Details						1 4 5 1 1 0 0 0 0 0 0	
Description of Change:							
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. SN54HC244, SN74HC244							
INSTRUMENTS SCLS130F – DECEMBER 1982 – REVISED MAY 2022							
Changes from Revision E (May 2016) to Revi	sion F (Ma	y 2022)			Page	
Junction-to-ambient them			<u> </u>	funct	ion		
The datasheet number wil	l ho changing						
The datasheet number will Device Family	Chan	Change From:		Change To:			
Device Fairling			-				
SNx4HC244			S130E SCLS130F		30F		
These changes may be rev	viewed at the da	atasheet li	nks provided.				
http://www.ti.com/produc			- р				
Error! Bookmark not defined.							
Reason for Change:							
To accurately reflect device characteristics.							
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):							
No anticipated impact of Fit, Form, Function, Quanty of Renability (positive / negative). No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.							
Changes to product identification resulting from this notification:							
None.							
Product Affected:							
SN74HC244APWR S	N74HC244DWRE	4	SN74HC244NSR		5	SN74HC244PWR	
SN74HC244DBR S	N74HC244DWRG	4	SN74HC244NSRG4		S	SN74HC244PWRE4	
SN74HC244DW S	N74HC244N		SN74HC244PW		S	SN74HC244PWRG4	
SN74HC244DWE4	N74HC244NE4		SN74HC244PWE	E4	S	SN74HC244PWT	
SN74HC244DWR	N74HC244NS		SN74HC244PWC	G4			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN www admin_team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.